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THERMAL PERFORMANCE					
PARAMETER		SYMBOL	TYP	UNIT	
Junction-to-case thermal resistance	MUR820	$R_{\Theta JC}$	3	°C/W	
Junction-to-case thermal resistance	MUR840 MUR860	R _{eJC}	2	°C/W	

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	MUR820			-	0.975	V
Forward voltage ⁽¹⁾	MUR840	I _F = 8A, T _J = 25°C	V _F	-	1.300	V
	MUR860			-	1.700	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	- I _R	-	5	μA
Reverse current @ rated v _R	Tated V_R $T_J = 100^{\circ}C$			-	250	μA
_	MUR820	IF = 0.5A, IR = 1.0A		-	25	ns
Reverse recovery time	MUR840 MUR860	Irr = 0.25A	t _{rr}	-	50	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾⁽²⁾	PACKAGE	PACKING			
MUR8x	TO-220AC	50 / Tube			
MUR8xH	TO-220AC	50 / Tube			

Notes:

- 1. "x" defines voltage from 200V(MUR820) to 600V(MUR860)
- 2. "H" means AEC-Q101 qualified



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

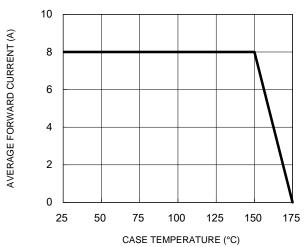


Fig.3 Typical Reverse Characteristics

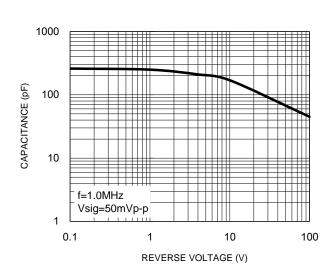
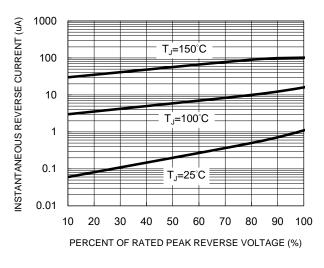


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



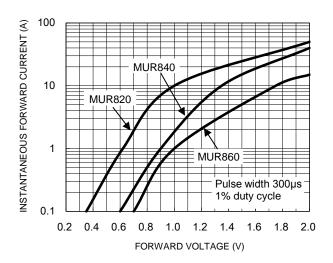
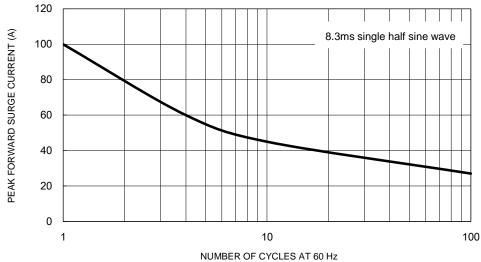


Fig.5 Maximum Non-Repetitive Forward Surge Current



3

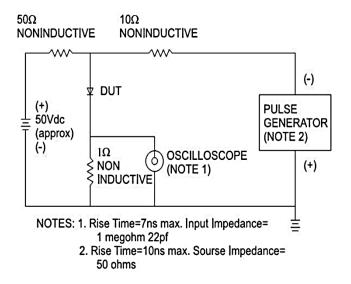


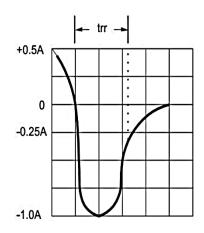
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CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

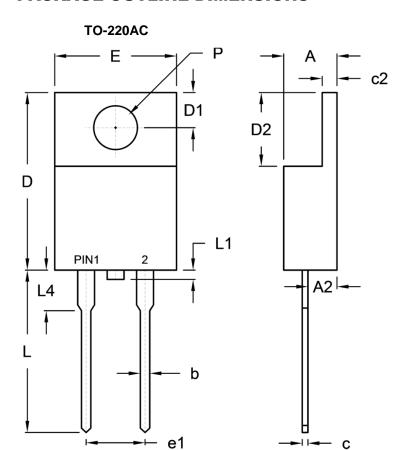








PACKAGE OUTLINE DIMENSIONS



DIM.	Unit (mm)		Unit (inch)		
DIW.	Min.	Max.	Min.	Max.	
Α	4.42	4.76	0.174	0.187	
A2	2.20	2.80	0.087	0.110	
b	0.68	0.94	0.027	0.037	
С	0.35	0.64	0.014	0.025	
c2	1.14	1.40	0.045	0.055	
D	14.60	16.00	0.575	0.630	
D1	2.62	3.44	0.103	0.135	
D2	5.84	6.86	0.230	0.270	
E	-	10.50	-	0.413	
e1	4.95	5.20	0.195	0.205	
L	13.19	14.79	0.519	0.582	
L1	0.00	1.60	0.000	0.063	
L4	2.80	4.20	0.110	0.165	
Р	3.54	4.00	0.139	0.157	

MARKING DIAGRAM



P/N = Marking Code

G = Green Compound

YWW = Date Code F = Factory Code

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